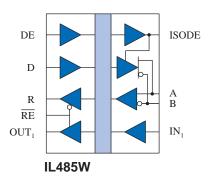


Isolated RS485 Interface With Handshake

Functional Diagram



V _{ID} (A–B)	DE	RE	ISODE	R	D	Mode
≥ 200 mV	L	L	L	Н	X	Receive
≤-200 mV	L	L	L	L	X	Receive
$-7 < V_I < 12$	X	Н	X	Z	X	Receive/Drive
≥ 1.5 V	Н	L	Н	Н	Н	Drive
≤-1.5 V	Н	L	Н	L	L	Drive
Open	L	L	L	Н	X	Indeterminate

H = High Level, L = Low LevelX = Irrelevant, Z = High Impedance

RE	IN1	OUT1
L	L	L
L	Н	Н
Н	X	Z

Features

- 2500 V_{RMS} Isolation (1 min.)
- 25 ns Maximum Propagation Delay
- 35 Mbps Data Rate
- 1 ns Pulse Skew (typ.)
- Designed for Multi-point Transmission on Long Bus Lines in Noisy Environments
- ±60 mA Driver Output Capability
- Thermal Shutdown Protection
- Meets or Exceeds ANSI RS-485 and ISO 8482:1987(E)
- -40°C to +85°C Temperature Range
- PROFIBUS International Component Recognition
- 16-Pin SOIC Package
- UL1577 and IEC 61010-2001 Approval

Applications

- Profibus/RS485 Systems
- Multiple Data Point Transmission

Description

The IL485W is a galvanically isolated, high-speed differential bus transceiver, designed for bidirectional data communication on balanced transmission lines. The devices use NVE's patented* IsoLoop spintronic Giant Magnetoresistance (GMR) technology. The IL485W is the first isolated RS-485 interface in a standard 16-pin SOIC package that meets the ANSI Standards EIA/TIA-422-B and RS-485 and is compatible with 3.3V input supplies.

The IL485W has current limiting and thermal shutdown features to protect against output short circuits and bus contention situations that could cause excessive power dissipation.

With 1 ns pulse skew and 16 ns propagation delay, the IL485W is ideal for PROFIBUS applications.

DE/ISODE and IN1/OUT1 allow isolated RTSAS and DTSAS handshaking.



Absolute Maximum Ratings(11)

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Storage Temperature	T_{s}	-65		150	°C	
Ambient Operating Temperature	T_A	-40		100	°C	
Voltage Range at A or B Bus Pins		-7		12	V	
Supply Voltage ⁽¹⁾	V_{DD1}, V_{DD2}	-0.5		7	V	
Digital Input Voltage		-0.5		5.5	V	
Digital Output Voltage		-0.5		$V_{DD} + 1$	V	
Continuous Total Power Dissipation				725 377	mW	25°C 85°C
Maximum Output Current	I_{o}			95	mA	
Lead Solder Temperature				260	°C	10 sec.
ESD			2		kV	HBM

Recommended Operating Conditions

Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions		
Supply Voltage	$V_{\rm DD1}, V_{\rm DD2}$	4.5		5.5	V			
Input Voltage at any Bus Terminal	$V_{\rm I}$			12	V			
(separately or common mode)	$V_{\rm IC}$			-7				
High-Level Digital Input Voltage	V_{IH}	3.0		V_{DD1}	V			
Low-Level Digital Input Voltage	$V_{\rm IL}$	0		0.8	V			
Differential Input Voltage ⁽²⁾	$V_{ ext{ID}}$			+12/-7	V			
High-Level Output Current (Driver)	I_{OH}			60	mA			
High-Level Digital Output Current	Ţ			8	mA			
(Receiver)	I_{OH}			0	IIIA			
Low-Level Output Current (Driver)	I_{OL}	-60			mA			
Low-Level Digital Output Current	I_{OL}	-8			mA			
(Receiver)	1 _{OL}	8			ША			
Ambient Operating Temperature	T_A	-40		85	°C			
Transient Immunity	20				kV/μs			
Digital Input Signal	+ +			DC S4	tabla			
Rise and Fall Times	$t_{\rm IR},t_{\rm IF}$		DC Stable					

Insulation Specifications

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Parameters	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Creepage Distance		8.08				mm
Barrier Impedance			>10 ¹⁴ 7			$\Omega \parallel pF$
Leakage Current			0.2		uА	240 V _{PMS} , 60 Hz

Safety and Approvals

IEC61010-1

TUV Certificate Numbers:

N1502812, N1502812-101

Classification: Reinforced Insulation

Model	Package	Pollution Degree	Material Group	Max. Working Voltage
IL485W	0.3" SOIC	II	III	$300 \mathrm{V}_{\mathrm{RMS}}$

<u>UL 1577</u>

Component Recognition Program File Number: E207481

Rated $2500V_{RMS}$ for 1 minute

Soldering Profile

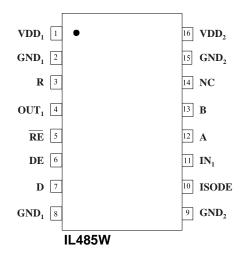
Per JEDEC J-STD-020C, MSL=2





IL485W Pin Connections

1	V_{DD1}	Input Power Supply
2	GND_1	Input Power Supply Ground Return
3	R	Output Data from Bus
4	OUT ₁	Output from Auxiliary Isolation Channel
5	RE	Read Data Enable (if RE is high, R= high impedance)
6	DE	Drive Enable
7	D	Data Input to Bus
8	GND_1	Input Power Supply Ground Return
9	GND_2	Output Power Supply Ground Return
10	ISODE	Isolated DE Output for use in Profibus applications where the state of the isolated drive enable node needs to be monitored
11	IN ₁	No Internal Connection
12	A	Non-inverting Bus Line
13	В	Inverting Bus Line
14	NC	No Internal Connection
15	GND ₂	Output Power Supply Ground Return
16	V_{DD2}	Output Power Supply





Driver Section

Electrical specifications are T_{min} to T_{max} and $V_{DD} = 4.5 \text{ V}$ to = 5.5 V unless otherwise stated.

Parameters	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Input Clamp Voltage	V_{ik}			-1.5	V	$I_L = -18 \text{ mA}$
Output voltage	V_{o}	0		6	V	$I_0 = 0$
Differential Output Voltage ⁽²⁾	$ V_{OD1} $	1.5		6	V	$I_{O} = 0$
Differential Output Voltage ⁽²⁾	$ V_{OD2} $	1.5	2.5	5	V	$R_L = 54 \Omega, V_{DD} = 5 V$
Differential Output Voltage ⁽²⁾⁽⁶⁾	V_{od3}	1.5		5	V	$R_L = 54 \Omega, V_{DD} = 4.5 V$
Change in Magnitude of Differential Output Voltage ⁽⁷⁾	$\Delta V_{\rm OD} $			±0.2	V	$R_L = 54 \Omega \text{ or } 100 \Omega$
Common Mode Output Voltage	V_{oc}			3 -1	V	$R_L = 54 \Omega \text{ or } 100 \Omega$
Change in Magnitude of Common Mode Output Voltage ⁽⁷⁾	$\Delta V_{\rm OC} $			±0.2	V	$R_L = 54 \Omega \text{ or } 100 \Omega$
Output Current ⁽⁴⁾ Output Disabled	I_{o}			1 -0.8	mA	$V_o = 12 \text{ V}$ $V_o = -7 \text{ V}$
High Level Input Current	$ m I_{IH}$			10	μΑ	$V_{I} = 3.5 \text{ V}$
Low Level Input Current	${ m I}_{ m IL}$			-10	μΑ	$V_I = 0.4 \text{ V}$
				250		$V_0 = -6 \text{ V}$
Short-circuit Output Current	I_{os}			-150	mA	$V_0 = 0 V$
				-250		$V_0 = 8 \text{ V}$
Supply Current	$I_{ ext{DD1}}$		4	6	mA	No Load
Supply Culton						(Outputs Enabled)
		Switching Spe			T =	
Parameters	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Maximum Data Rate		35			Mbps	$R_L = 54 \Omega, C_L = 50 pF$
Differential Output Prop Delay	$t_D(OD)$		16	25	ns	$R_{L} = 54 \Omega, C_{L} = 50 pF$
Pulse Skew ⁽¹⁰⁾	$t_s(P)$		1	6	ns	$R_L = 54 \Omega$, $C_L = 50 pF$
Differential Output Rise & Fall Time	$t_{T}(OD)$		8	10	ns	$R_{L} = 54 \Omega, C_{L} = 50 \text{ pF}$
Output Enable Time To High Level	t_{PZH}		31	65	ns	$R_L = 54 \Omega$, $C_L = 50 pF$
Output Enable Time To Low Level	t_{PZL}		22	35	ns	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Output Disable Time From High Level	t_{PHZ}		28	50	ns	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Output Disable Time From Low Level	t_{PLZ}		16	32	ns	$R_L = 54 \Omega, C_L = 50 pF$
Skew Limit ⁽³⁾	$t_{SK}(LIM)$		2	12	ns	$R_L = 54 \Omega, C_L = 50 pF$

Notes (apply to both driver and receiver sections):

- 1. All voltage values are with respect to network ground except differential I/O bus voltages.
- 2. Differential input/output voltage is measured at the noninverting terminal A with respect to the inverting terminal B.
- 3. Skew limit is the maximum propagation delay difference between any two devices at 25°C.
- The power-off measurement in ANSI Standard EIA/TIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs.
- 5.
- All typical values are at V_{DD1} , $V_{DD2} = 5$ V or $V_{DD1} = 3.3$ V and $T_A = 25^{\circ}$ C. The minimum V_{OD2} with a 100 Ω load is either ½ V_{OD1} or 2 V, whichever is greater. 6.
- $\Delta |V_{oo}|$ and $\Delta |V_{oo}|$ are the changes in magnitude of V_{oo} and V_{oo} , respectively, that occur when the input is changed from one logic state to
- This applies for both power on and power off, refer to ANSI standard RS-485 for exact condition. The EIA/TIA-422-B limit does not apply for a combined driver and receiver terminal.
- Includes 8 ns read enable time. Maximum propagation delay is 25 ns after read assertion.
- 10. Pulse skew is defined as $|t_{PLH} t_{PHL}|$ of each channel.



Receiver Section

Electrical specifications are T_{min} to T_{max} and $V_{DD} = 4.5 \text{ V}$ to = 5.5 V unless otherwise stated.

Parameters	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Positive-going Input Threshold Voltage	$V_{\rm IT+}$			0.2	V	$V_0 = 2.7 \text{ V},$ $I_0 = -0.4 \text{ mA}$
Negative-going Input Threshold Voltage	$V_{\text{IT-}}$	-0.2			V	$V_0 = 0.5 \text{ V},$ $I_0 = 8 \text{ mA}$
Hysteresis Voltage (V _{IT+} – V _{IT-})	V_{HYS}		60		mV	
High Level Digital Output Voltage	V_{OH}	$V_{DD} - 0.2$			V	$V_{ID} = 200 \text{ mV}$ $I_{OH} = -20 \mu\text{A}$
Low Level Digital Output Voltage	V_{oL}			0.2	V	$V_{ID} = -200 \text{ mV}$ $I_{OH} = 20 \mu\text{A}$
High-impedance-state output current	I_{OZ}			±20	μΑ	$V_0 = 0.4 \text{ to } (V_{DD2} - 0.5) \text{ V}$
Line Input Current ⁽⁸⁾	I_{I}			1 -0.8	mA	$V_{I} = 12 \text{ V}$ $V_{I} = -7 \text{ V}$ Other Input ⁽¹¹⁾ = 0 V
Input Resistance	$r_{\rm I}$	12	20		kΩ	
Supply Current	I_{DD2}		27	34	mA	No load Outputs Enabled
	S	witching Char				
Parameters	Symbol	Min.	Typ. ⁽⁵⁾	Max.	Units	Test Conditions
Maximum Data Rate		35			Mbps	$R_{L} = 54 \Omega, C_{L} = 50 \text{ pF}$
Propagation Delay ⁽⁹⁾	$t_{ m PD}$		24	32	ns	$V_0 = -1.5 \text{ V to } 1.5 \text{ V},$ $C_L = 15 \text{ pF}$
Pulse Skew ⁽¹⁰⁾	t _{sk} (P)		1	6	ns	$V_0 = -1.5 \text{ V to } 1.5 \text{ V},$ $C_L = 15 \text{ pF}$
Skew Limit ⁽³⁾	$t_{SK}(LIM)$		2	8	ns	$R_L = 54 \Omega, C_L = 50 \text{ pF}$
Output Enable Time To High Level	$t_{ m PZH}$		17	24	ns	$C_L = 15 \text{ pF}$
Output Enable Time To Low Level	t_{PZL}		30	45	ns	$C_L = 15 \text{ pF}$
Output Disable Time From High Level	$t_{ m PHZ}$		30	45	ns	$C_L = 15 \text{ pF}$
Output Disable Time From Low Level	t_{PLZ}		18	27	ns	$C_L = 15 \text{ pF}$

Electrostatic Discharge Sensitivity

This product has been tested for electrostatic sensitivity to the limits stated in the specifications. However, NVE recommends that all integrated circuits be handled with appropriate care to avoid damage. Damage caused by inappropriate handling or storage could range from performance degradation to complete failure.



Application Information

Dynamic Power Consumption

IsoLoop Isolators achieve their low power consumption from the way they transmit data across the isolation barrier. By detecting the edge transitions of the input logic signal and converting these to narrow current pulses, a magnetic field is created around the GMR Wheatstone bridge. Depending on the direction of the magnetic field, the bridge causes the output comparator to switch following the input logic signal. Since the current pulses are narrow, about 2.5 ns, the power consumption is independent of mark-to-space ratio and solely dependent on frequency. This has obvious advantages over optocouplers, which have power consumption heavily dependent on frequency and time.

The approximate power supply current per channel is:

$$I_{\rm IN} = 40~x~\frac{f}{f_{\rm MAX}}~x~\frac{1}{4}~mA$$

Where f =operating frequency

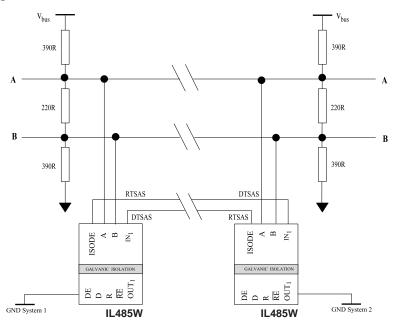
$$f_{MAX} = 50 \text{ MHz}$$

Power Supply Decoupling

Both V_{DD1} and V_{DD2} must be bypassed with 47 nF ceramic capacitors. These should be placed as close as possible to V_{DD} pins for proper operation. Additionally, V_{DD2} should be bypassed with a 10 μ F tantalum capacitor.

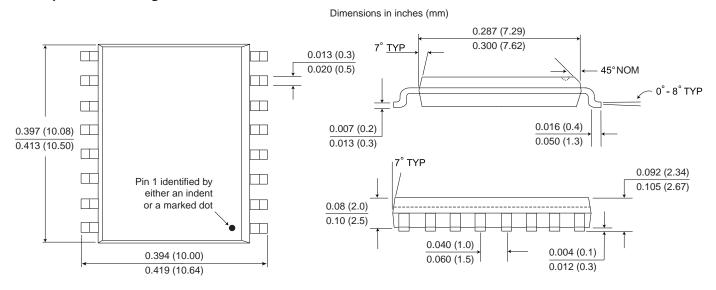
Application

PROFIBUS Fault Interrogation

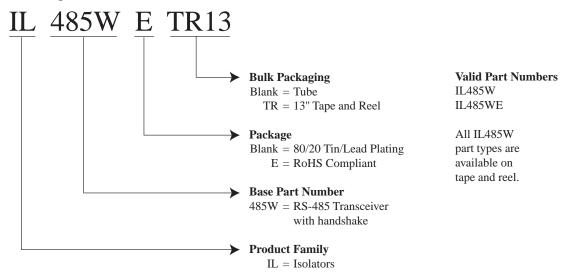




0.3" 16-pin SOIC Package



Ordering Information and Valid Part Numbers



RoHS COMPLIANT



ISB-DS-001-IL485W-M September 2007

Changes

• Changed ordering information to reflect that devices are now fully RoHS compliant with no exemptions.

ISB-DS-001-IL485W-L

Changes

• Reorganized supply current specifications; misc. minor changes

ISB-DS-001-IL485W-K April 2007

Changes

• Eliminated soldering profile chart

ISB-DS-001-IL485W-J December 2006

Changes

• Updated open input state in truth table

ISB-DS-001-IL485W-I

Changes

• Updated package drawing; misc.

ISB-DS-001-IL485W-H

Changes

• Update UL and IEC approvals

ISB-DS-001-IL485W-G

Changes

- Revision letter added.
- Ordering Information removed.
- IEC 61010-1 Classification "Reinforced Insulation" added.
- Notes added.
- Electrostatic Discharge Sensitivity note moved to page 5.
- Electrostatic Discharge Sensitivity Note added.
- Notes moved to page 3.
- Ordering Information added.



About NVE

An ISO 9001 Certified Company

NVE Corporation manufactures innovative products based on unique spintronic Giant Magnetoresistive (GMR) technology. Products include Magnetic Field Sensors, Magnetic Field Gradient Sensors (Gradiometers), Digital Magnetic Field Sensors, Digital Signal Isolators, and Isolated Bus Transceivers.

NVE pioneered spintronics and in 1994 introduced the world's first products using GMR material, a line of ultra-precise magnetic sensors for position, magnetic media, gear speed and current sensing.

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ISB-DS-001-IL485W-M

September 2007